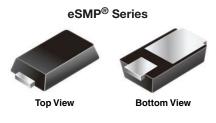
### VS-1EQH01-M3, VS-1EQH02-M3

**Vishay Semiconductors** 

# Ultrafast Rectifier, 1 A FRED Pt<sup>®</sup>



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#### MicroSMP (DO-219AD)

Anode O Cathode

#### LINKS TO ADDITIONAL RESOURCES



SHAY

PRIMARY CHARACTERISTICS					
I <sub>F(AV)</sub>	1 A				
V <sub>R</sub>	100 V, 200 V				
V <sub>F</sub> at I <sub>F</sub>	0.72 V				
t <sub>rr</sub> (typ.)	33 ns				
I <sub>FSM</sub>	30 A				
T <sub>J</sub> max.	175 °C				
Package	MicroSMP (DO-219AD)				
Circuit configuration	Single				

#### **FEATURES**

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement
- · Low forward voltage drop, low power losses
- · Low leakage current
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- For PFC, CRM snubber operation
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

#### **TYPICAL APPLICATIONS**

For use in high frequency, freewheeling, DC/DC converters, PFC, and in snubber industrial and automotive applications.

### **MECHANICAL DATA**

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating

Terminals: matte tin plated leads, solderable per J-STD-002, meets JESD 201 class 2 whisker test

Polarity: color band denotes cathode end

ABSOLUTE MAXIMUM R	ATINGS					
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Deale repetitive reverse veltage	VS-1EQH01-M3	M		100	V	
Peak repetitive reverse voltage	VS-1EQH02-M3	V <sub>RRM</sub>		200	v	
Average rectified forward current		I <sub>F(AV)</sub>	T <sub>M</sub> = 159 °C	1	^	
Non-repetitive peak surge current		I <sub>FSM</sub>	$T_J = 25 \ ^{\circ}C$ , 10 ms sine pulse	30	A	
Operating junction and storage temperatures		T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C	

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Breakdown voltage,	VS-1EQH01-M3	V <sub>BR</sub> ,	V <sub>BB</sub> , 1004		-	-		
blocking voltage	VS-1EQH02-M3	V <sub>R</sub>	I <sub>R</sub> = 100 μΑ	200			v	
Forward voltage		V	I <sub>F</sub> = 1 A	-	0.88	0.97		
		V <sub>F</sub>	I <sub>F</sub> = 1 A, T <sub>J</sub> = 150 °C	-	0.72	0.75		
Reverse leakage current		I <sub>R</sub>	$V_R = V_R$ rated	-	-	1		
			$T_J = 150 \text{ °C}, V_R = V_R \text{ rated}$	-	-	25	μA	
Junction capacitance		CT	V <sub>R</sub> = 200 V	-	6	-	pF	

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## VS-1EQH01-M3, VS-1EQH02-M3

### **Vishay Semiconductors**

<b>DYNAMIC RECOVERY CHARACTERISTICS</b> ( $T_J = 25$ °C unless otherwise specified)								
PARAMETER	SYMBOL	TEST CO	TEST CONDITIONS			MAX.	UNITS	
		I <sub>F</sub> = 1.0 A, dI <sub>F</sub> /dt =	$\approx$ 50 A/µs, V <sub>R</sub> = 30 V	-	33	-		
Boverne recevent time	+	I <sub>F</sub> = 0.5 A, I <sub>R</sub> = 1 A	A, I <sub>rr</sub> = 0.25 A	-	-	23	20	
Reverse recovery time	t <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	13	-	A nC	
		T <sub>J</sub> = 125 °C	I <sub>F</sub> = 1 A dI <sub>F</sub> /dt = 200 A/μs V <sub>B</sub> = 100 V	-	18	-		
Deels receiver a current		T <sub>J</sub> = 25 °C		-	1.8	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 125 °C		-	2.7	-		
	Q <sub>rr</sub>	T <sub>J</sub> = 25 °C		-	11	-		
Reverse recovery charge		T <sub>J</sub> = 125 °C		-	23	-		

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Maximum junction and storage temperature range	T <sub>J</sub> , T <sub>Stg</sub>		-55	-	175	°C	
Thermal resistance, junction to mount	R <sub>thJM</sub> <sup>(1)</sup>		-	16	20		
Thermal resistance, junction to ambient	R <sub>thJA</sub>	Device mounted on FR4 PCB, 2 oz. standard footprint	-	160	-	°C/W	
Marking device VS-1EQH01-M3		Case style MicroSMP (DO-219AD)		1H1			
VS-1EQH02-M3		Case style MICIOSIVIF (DO-219AD)	1H2				

#### Note

<sup>(1)</sup> Thermal resistance junction to mount follows JEDEC<sup>®</sup> 51-14 transient dual interface test method (TDIM)

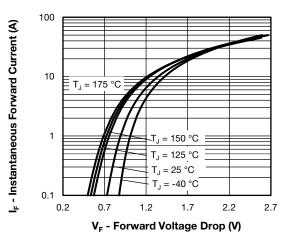


Fig. 1 - Typical Forward Voltage Drop Characteristics

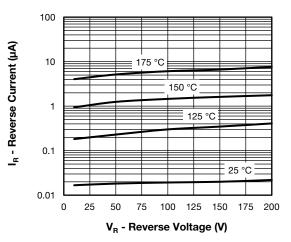
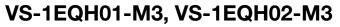


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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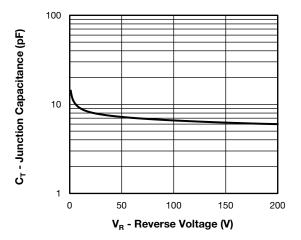


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

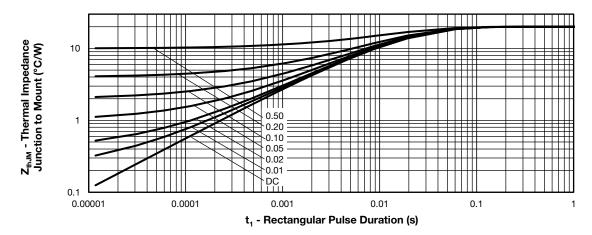
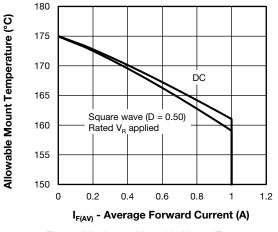
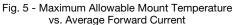


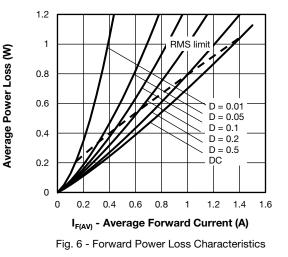
Fig. 4 - Maximum Transient Thermal Impedance, Junction to Mount







 $\begin{array}{l} \mbox{Formula used: } T_M = T_J - (Pd + Pd_{REV}) \times R_{thJM}; \\ Pd = \mbox{forward power loss} = I_{F(AV)} \times V_{FM} \mbox{ at } (I_{F(AV)}/D) \mbox{ (see fig. 5); } \\ Pd_{REV} = \mbox{inverse power loss} = V_{R1} \times I_R \mbox{ (1 - D); } I_R \mbox{ at } V_{R1} = \mbox{rated } V_R \end{array}$ 



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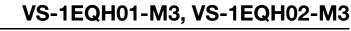
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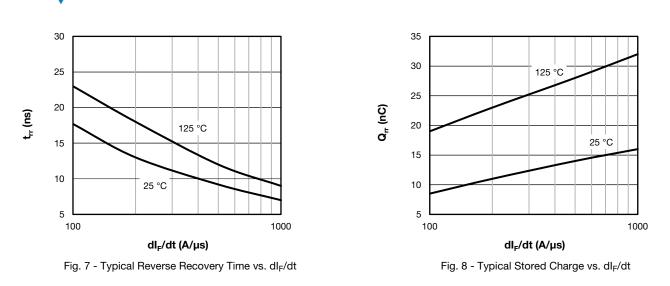
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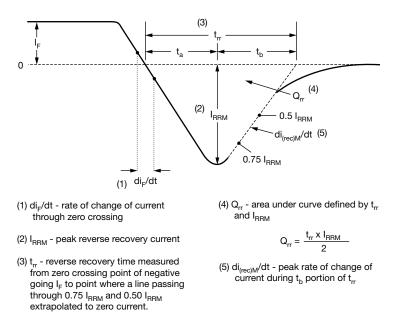


Fig. 9 - Reverse Recovery Waveform and Definitions

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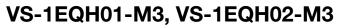
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### **ORDERING INFORMATION TABLE**

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Device code	VS-	1	Е	Q	н	02	Н	М3
		2	3	4	5	6	7	8
	1 · 2 · 3 ·	Cur Circ	nay Sen rent rati cuit conf single c	ng (1 = iguratior	1 A)	oduct		
	4 - 5 -		MicroS cess typ		kage			
	6 - 7 -	- Volt	ultrafas age coo AEC-Q	le (02 =	200 V)			
	8 -		= halog			complia	nt, and	termina

ORDERING INFORMATION (Example)						
PREFERRED P/N	PREFERRED PACKAGE CODE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-1EQH01-M3/H	Н	4500	7" diameter plastic tape and reel			
VS-1EQH02-M3/H	Н	4500	7" diameter plastic tape and reel			

LINKS TO RELATED DOCUMENTS					
Dimensions	www.vishay.com/doc?96591				
Part marking information	www.vishay.com/doc?96590				
Packaging information	www.vishay.com/doc?88869				
SPICE model	www.vishay.com/doc?96594				

5

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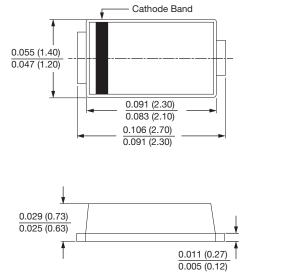


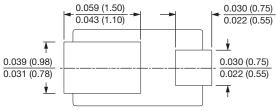
### **Outline Dimensions**

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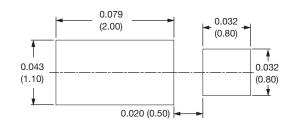
# MicroSMP (DO-219AD), FRED Pt®

### **DIMENSIONS** in inches (millimeters)





Mounting Pad Layout



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